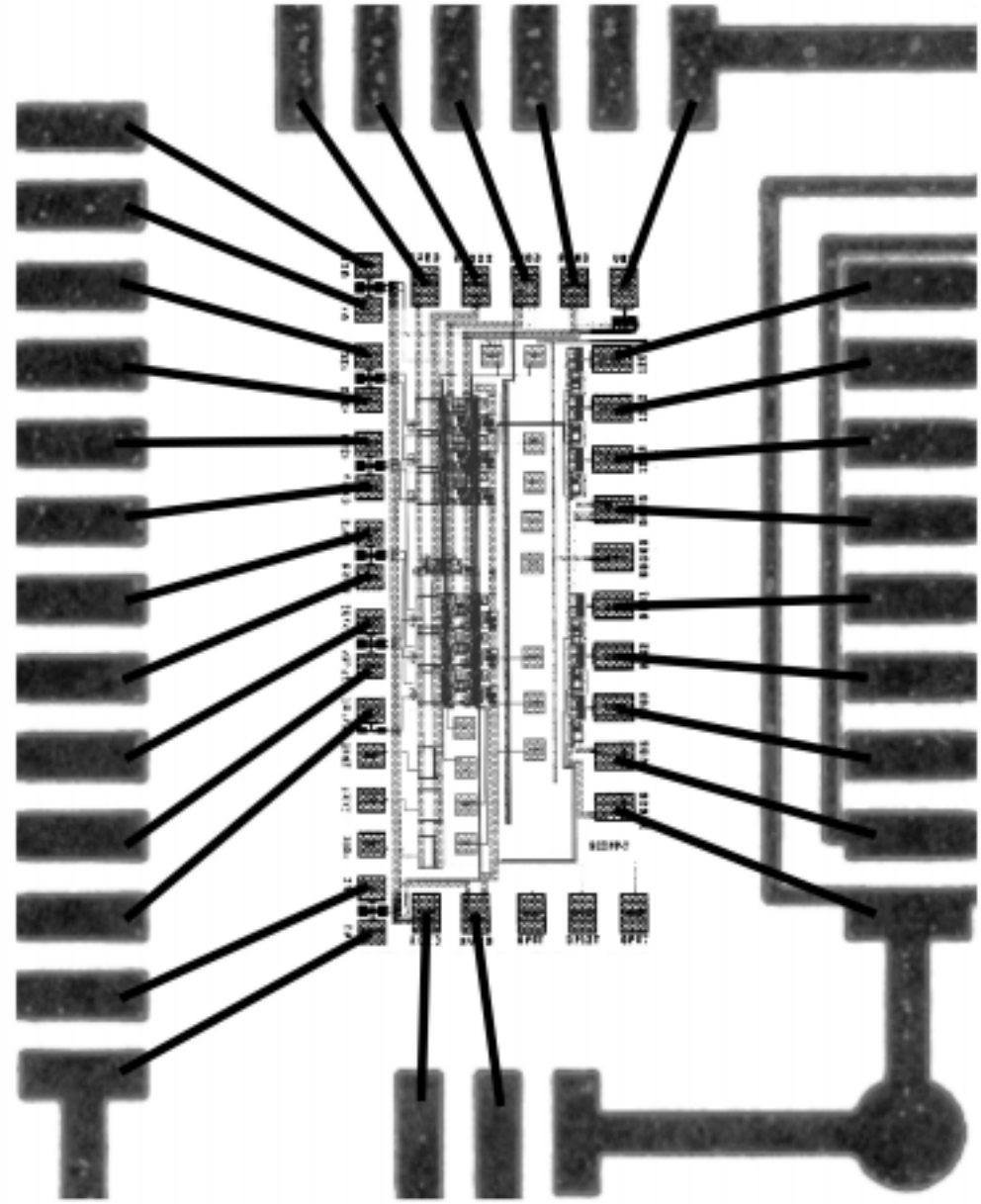Bonding Diagram of HP half-micron test chip version 2 on Liz board III